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	As a b	a below named inventor, I hereby declare that:												
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## **DOCKET NO. 1263-0009US**

**PATENT** 

I hereby claim the benefit under 35 U.S.C. § 120/365/119 and 37 CFR § 1.78 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status (patented, pending)		

I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: SHREEN K. DANAMRAJ, Reg. No. 41,696 of the firm of SMITH, DANAMRAJ & YOUST, P.C., 12900 Preston Road, Suite 1200, LB-15, Dallas, TX 75230-1320.

Address all telephone calls and correspondence to:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Richard S. Roy Full Name	Inventor's Signature	Date			
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